



80V N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	R _{DS(ON)}	I _D Tc = +25°C
80V	7.8mΩ @ V _{GS} = 10V	83A

Description and Applications

This new generation MOSFET is designed to minimize RDS(ON) yet maintain superior switching performance. This device is ideal for use in power management and load switches.

- DC-DC converters
- Load switches

Features

- 100% Unclamped Inductive Switching (UIS) Test in Production -Ensures More Reliable and Robust End Application
- High-Conversion Efficiency
- Low RDS(ON) Minimizes On-State Losses
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

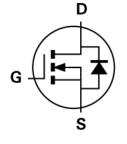
Mechanical Data

- Package: PowerDI[®]5060-8
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.097 grams (Approximate)

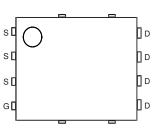


PowerDI5060-8/SWP (Type UX)

Site 2:



Internal Schematic

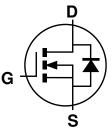


Top View Pin Configuration

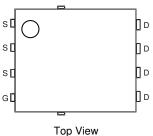


Top View

Bottom View



Internal Schematic



Pin Configuration

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



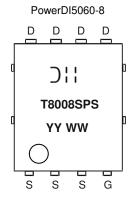
Ordering Information (Note 4)

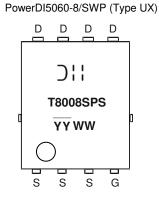
Part Number	Package	Packing		
Part Number	Package	Qty.	Carrier	
DMT8008SPS-13	PowerDI5060-8	2,500	Tape & Reel	
DIWI 60063F3-13	PowerDI5060-8/SWP (Type UX)	2,500	Tape & Reel	

Note:

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information





☐ Street Street

Maximum Ratings (@Tc = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V _{DSS}	80	V
Gate-Source Voltage			Vgss	±20	V
Continuous Drain Current, $V_{GS} = 10V$ (Note 5) Steady $T_C = +25^{\circ}C$ State $T_C = +70^{\circ}C$			I _D	83 66	Α
Maximum Continuous Body Diode Forward Current (Note 5)			ls	69	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I _{DM}	330	Α
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)			lsм	330	Α
Avalanche Current, L = 0.1mH (Note 6)			las	40	Α
Avalanche Energy, L = 0.1mH (Note 6)			Eas	80	mJ

Thermal Characteristics (@Tc = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 7)	T _A = +25°C	P _D	1.3	W
Thermal Resistance, Junction to Ambient (Note 7)	Steady State	Reja	95	°C/W
Total Power Dissipation (Note 8)	T _A = +25°C	PD	2.8	W
Thermal Resistance, Junction to Ambient (Note 8)	Steady State	R _{0JA}	44	°C/W
Total Power Dissipation (Note 5)	T _C = +25°C	PD	83	W
Thermal Resistance, Junction to Case (Note 5)		Rejc	1.5	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Notes:

- 5. Thermal resistance from junction to soldering point (on the exposed drain pad).
- 6. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep T_J = +25°C.
- 7. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
- 8. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.



Electrical Characteristics (@T_C = +25°C, unless otherwise specified.)

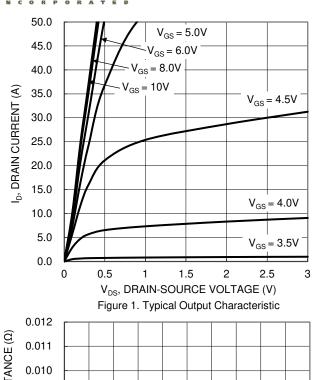
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)							
Drain-Source Breakdown Voltage	BVDSS	80	_	_	V	$V_{GS} = 0V, I_D = 1mA$	
Zero Gate Voltage Drain Current	IDSS	_	_	1	μA	V _{DS} = 64V, V _{GS} = 0V	
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 20V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage	V _{GS(TH)}	2	1	4	٧	V _{DS} = V _{GS} , I _D = 1mA	
Static Drain-Source On-Resistance	Process	-	6.5	7.8	mΩ	$V_{GS} = 10V, I_D = 14A$	
Static Drain-Source On-Nesistance	R _{DS(ON)}	_	7.8	11	11122	$V_{GS} = 6V, I_D = 12A$	
Diode Forward Voltage	V _{SD}	_	0.8	1.2	V	V _G S = 0V, I _S = 14A	
DYNAMIC CHARACTERISTICS (Note 10)	DYNAMIC CHARACTERISTICS (Note 10)						
Input Capacitance	Ciss		1950	_		401/1/	
Output Capacitance	Coss		826	_	pF	$V_{DS} = 40V$, $V_{GS} = 0V$ f = 1MHz	
Reverse Transfer Capacitance	Crss		56	_			
Gate Resistance	Rg	_	1.7	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 6V)	Qg		23	_			
Total Gate Charge (VGS = 10V)	Qg		34	_	nC	V _{DS} = 40V, I _D = 14A	
Gate-Source Charge	Qgs		6	_	IIC		
Gate-Drain Charge	Q_{gd}		12	_			
Turn-On Delay Time	td(ON)	_	8	_			
Turn-On Rise Time	tr	_	15	_	20	$\begin{split} V_{DD} &= 40 V, \ V_{GS} = 10 V \\ I_D &= 14 A, \ R_g = 6 \Omega \end{split}$	
Turn-Off Delay Time	tD(OFF)	_	29	_	ns		
Turn-Off Fall Time	t _F	_	21	_			
Body Diode Reverse Recovery Time	trr		43	_	ns	ls 144 dl/dt 1004/us	
Body Diode Reverse Recovery Charge	Qrr	_	49		nC	Is = 14A, dl/dt = 100A/µs	

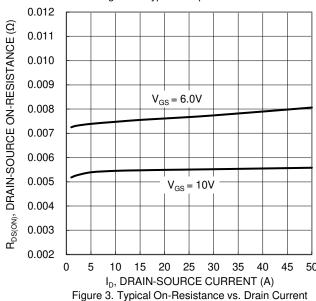
Notes:

^{9.} Short duration pulse test used to minimize self-heating effect. 10. Guaranteed by design. Not subject to product testing.









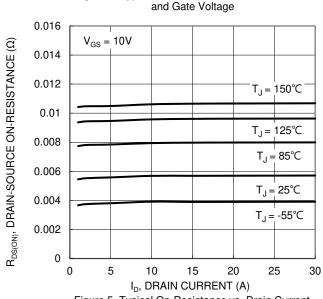


Figure 5. Typical On-Resistance vs. Drain Current and Temperature

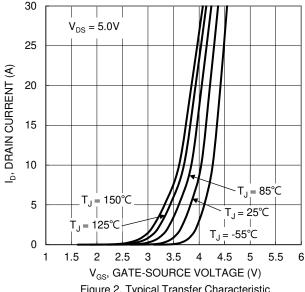
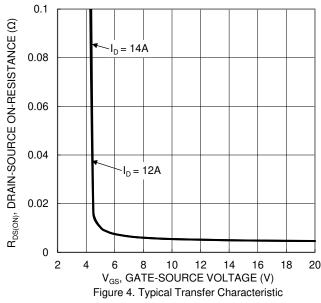


Figure 2. Typical Transfer Characteristic



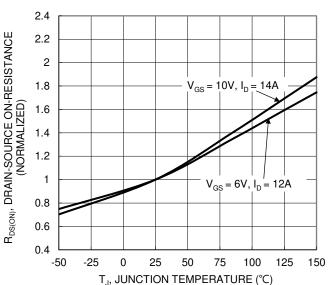
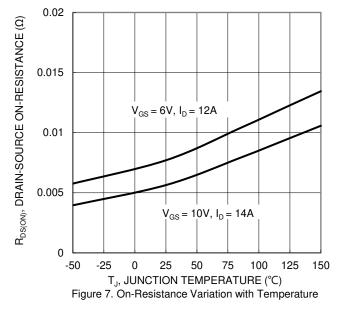
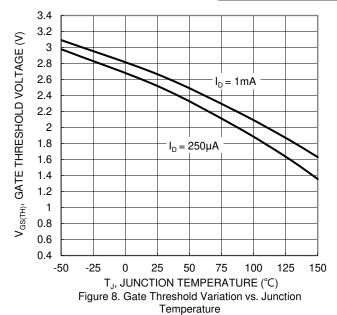


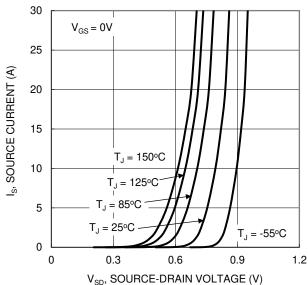
Figure 6. On-Resistance Variation with Temperature

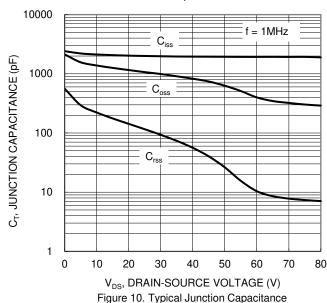












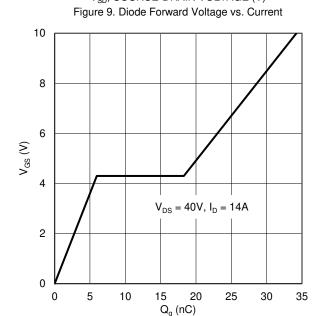
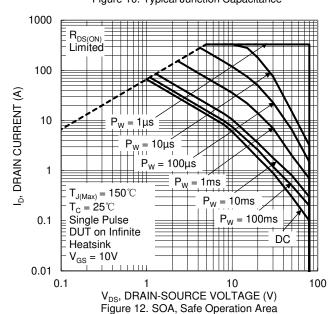
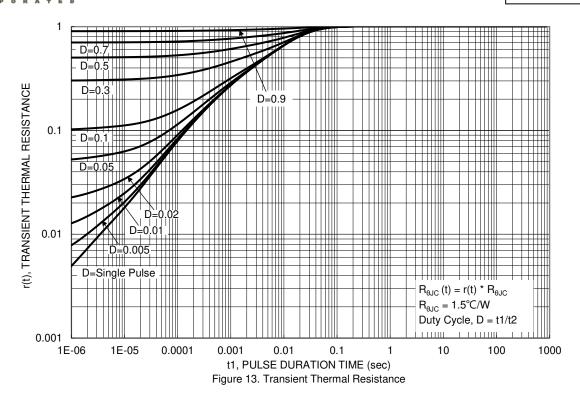


Figure 11. Gate Charge





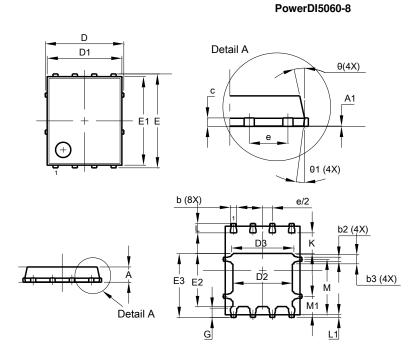




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

Site 1:



PowerDI5060-8				
Dim	Min	Max	Тур	
Α	0.90	1.10	1.00	
A1	0.00	0.05	-	
b	0.33	0.51	0.41	
b2	0.200	0.350	0.273	
b3	0.40	0.80	0.60	
C D	0.230	0.330	0.277	
		5.15 BSC		
D1	4.70	5.10	4.90	
D2	3.70	4.10	3.90	
D3	3.90	4.30	4.10	
Е	(6.15 BSC	;	
E1	5.60	6.00	5.80	
E2	3.28	3.68	3.48	
E3	3.99	4.39	4.19	
е		1.27 BSC	;	
G	0.51	0.71	0.61	
K	0.51	-	-	
L	0.51	0.71	0.61	
L1	0.100	0.200	0.175	
М	3.235	4.035	3.635	
M1	1.00	1.40	1.21	
Θ	10°	12°	11°	
Θ1	6°	8°	7°	
All Dimensions in mm				

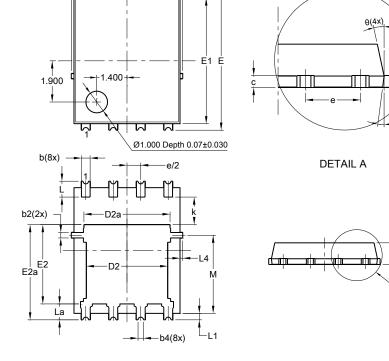
Site 2:

PowerDI5060-8/SWP (Type UX)

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DETAIL A

Seating Plane



PowerDI5060-8/SWP (Type UX)				
Dim	Min	Max	Тур	
Α	0.90	1.10	1.00	
A1	0	0.05		
b	0.30	0.50	0.41	
b2	0.20	0.35	0.25	
b4	C).25REF	=	
С	0.230	0.330	0.277	
D	5	.15 BS0	5	
D1	4.70	5.10	4.90	
D2	3.56	3.96	3.76	
D2a	3.78	4.18	3.98	
E	6	.40 BS0)	
E1	5.60	6.00	5.80	
E2	3.46	3.86	3.66	
E2a	4.195	4.595	4.395	
е	1.27BSC			
k	1.05			
L	0.635	0.835	0.735	
La	0.635	0.835	0.735	
L1	0.200	0.400	0.300	
L1a	0.050REF			
L4	0.025	0.225	0.125	
М	3.205	4.005	3.605	
θ	10°	12°	11°	
θ1	6°	8°	7°	
All Dimensions in mm				

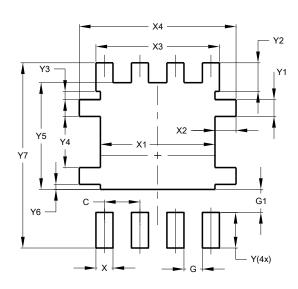


Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

Site 1:

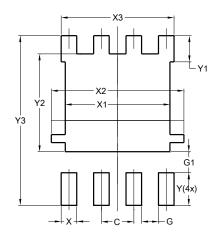
PowerDI5060-8



Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
Х	0.610
X1	4.100
X2	0.755
Х3	4.420
X4	5.610
Υ	1.270
Y1	0.600
Y2	1.020
Y3	0.295
Y4	1.825
Y5	3.810
Y6	0.180
Y 7	6.610

Site 2:

PowerDI5060-8/SWP (Type UX)



Dimensions	Value		
Dilliensions	(in mm)		
С	1.270		
G	0.660		
G1	0.820		
Χ	0.610		
X1	4.100		
X2	5.190		
Х3	4.420		
Υ	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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